Multilayer Ceramic Chip Capacitors

C3216X7R1E105K085AA (TDK item description : C3216X7R1E105KT****)

Applications		Commercial Grade	
	Δ	Please refer to Part No. CGA5L2X7R1E105K160AA for automotive use.	
Feature	General	General (Up to 50V)	
Series	C3216 [EIA CC1206]		



Size		
Length(L)	3.20mm +/-0.20mm	
Width(W)	1.60mm +/-0.20mm	
Thickness(T)	0.85mm +/-0.15mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	1.00mm Min.	
Recommended Land Pattern(PA)	2.10 to 2.50mm (Flow Soldering) 2.00 to 2.40mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	1.10 to 1.30mm (Flow Soldering) 1.00 to 1.20mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	1.00 to 1.30mm (Flow Soldering) 1.10 to 1.60mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

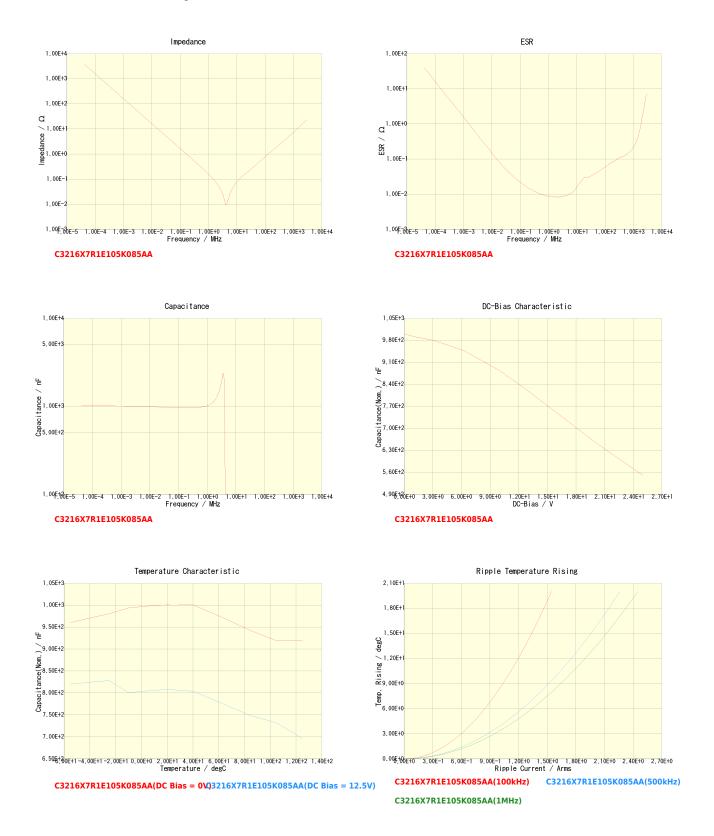
Electrical Characteristics				
Capacitance	1uF +/-10%			
Rated Voltage	25Vdc			
Temperature Characteristic	X7R(+/-15%)			
Dissipation Factor	3% Max.			
Insulation Resistance	500MΩ Min.			

Other				
Soldering Method	Reflow, Flow			
AEC Q200	No			
Packing	Blister (Plastic)Taping [180mm Reel]			
Package Quantity	4000Pcs Min.			

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Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



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